

Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			VDSS	40	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 5) V _{GS} = 10V	Steady State	T _A = +25°C T _A = +70°C	ID	9.6 7.7	А
Maximum Body Diode Continuous Current (Note 5)			Is	9.6	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%) (Note 6)			Ірм	37.7	Α
Pulsed Source Current (10µs Pulse, Duty Cycle = 1%) (Note 6)			Ism	37.7	Α

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

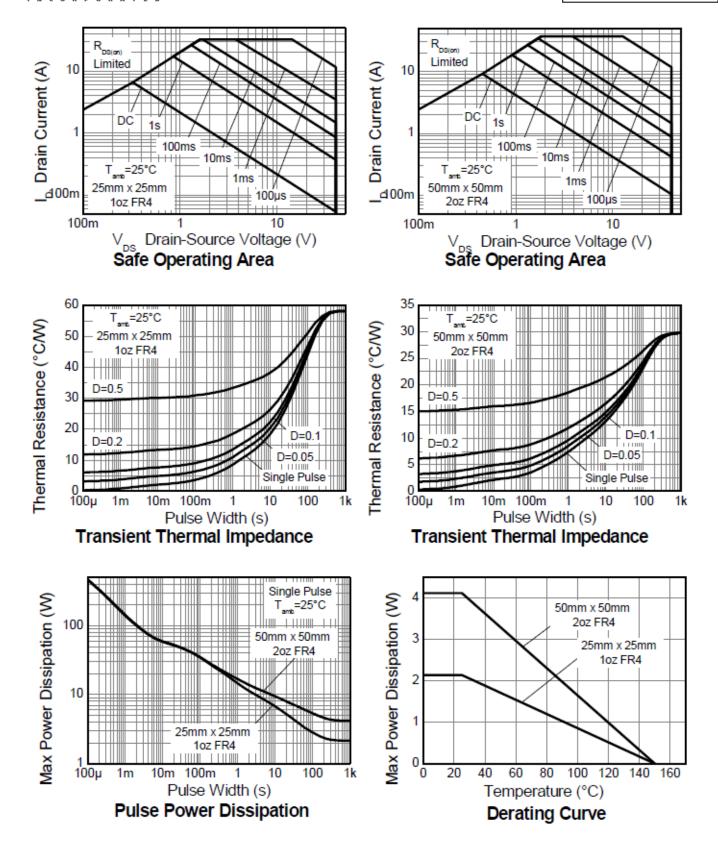
Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	4.18	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Reja	29.9	°C/W
Total Power Dissipation (Note 7)	T _A = +25°C	PD	2.14	W
Thermal Resistance, Junction to Ambient (Note 7)	Steady State	$R_{\theta JA}$	58.4	°C/W
Thermal Resistance, Junction to Case (Note 8)	·	R ₀ JC	2.46	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

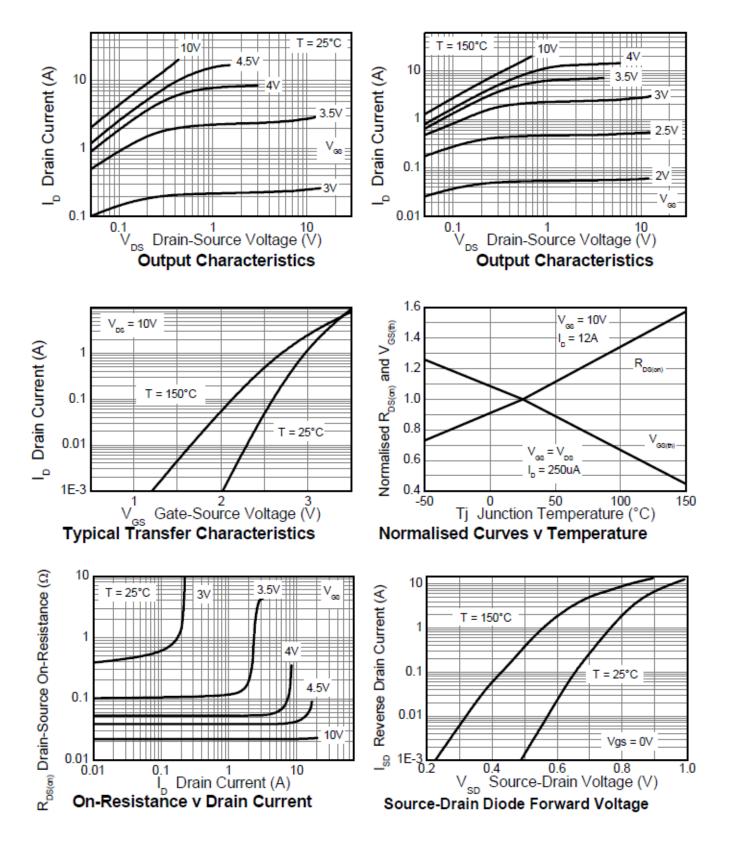
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BV _{DSS}	40		_	V	$V_{GS} = 0V, I_{D} = 250\mu A$	
Zero Gate Voltage Drain Current	IDSS		_	1	μA	$V_{DS} = 40V$, $V_{GS} = 0V$	
Gate-Source Leakage	Igss		_	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	Vgs(TH)	1		3	٧	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	Process	— 21 30 mΩ	V _{GS} = 10V, I _D = 12A				
Static Diain-Source On-Nesistance	R _{DS(ON)}		37	50	1112	$V_{GS} = 4.5V, I_{D} = 6A$	
Diode Forward Voltage	VsD		0.95	1.1	V	V _G S = 0V, I _S = 12A	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	Ciss		604	—		V _{DS} = 20V, V _{GS} = 0V, f = 1.0MHz	
Output Capacitance	Coss		106	_	pF		
Reverse Transfer Capacitance	Crss		59.6	_			
Total Gate Charge (VGS = 4.5V)	Qg		6.5	_		Vps = 20V, Ip = 12A	
Total Gate Charge (V _{GS} = 10V)	Q_g		12.9	_	nC		
Gate-Source Charge	Qgs		2.3	_	110	VDS = 20V, ID = 12A	
Gate-Drain Charge	Q_{gd}		3.6	_			
Turn-On Delay Time	t _{D(ON)}		4.2	_		$V_{DD} = 20V, I_{D} = 12A$ $V_{GS} = 10V, R_{G} = 6\Omega$	
Turn-On Rise Time	t _R		12.4	_	no		
Turn-Off Delay Time	tD(OFF)		13.8	_	ns		
Turn-Off Fall Time	tF		10.7				
Body Diode Reverse Recovery Time	trr	_	135	_	ns	I _F = 12A, di/dt = 100A/μs	
Body Diode Reverse Recovery Charge	Qrr	_	799	_	nC	I _F = 12A, di/dt = 100A/μs	

- Notes: 5. For a device surface mounted on 50mm x 50mm x 1.6mm FR-4 PCB with high coverage of single sided 2oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
 - 6. Same as note 5, except the device is pulsed with D = 0.02 and pulse width 300µs. The pulse current is limited by the maximum junction temperature.
 - 7. For a device surface mounted on 25mm x 25mm x 1.6mm FR-4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
 - 8. Thermal resistance from junction to solder-point (at the end of the drain lead).
 - 9. Short duration pulse test used to minimize self-heating effect.
 - 10. Guaranteed by design. Not subject to product testing.

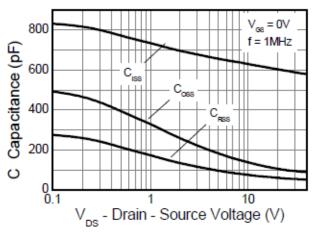


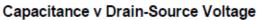


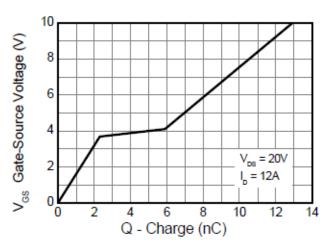










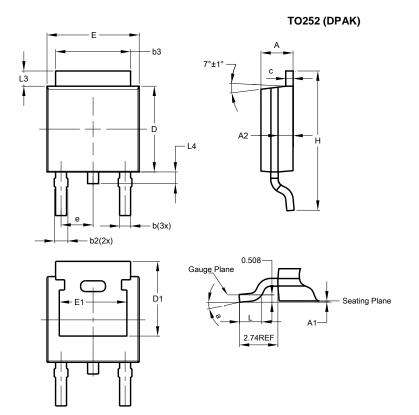


Gate-Source Voltage v Gate Charge



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

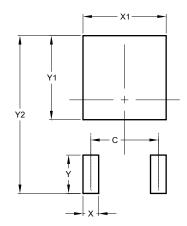


TO252 (DPAK)					
Dim	Min	Max	Тур		
Α	2.19	2.39	2.29		
A1	0.00	0.13	0.08		
A2	0.97	1.17	1.07		
b	0.64	0.88	0.783		
b2	0.76	1.14	0.95		
b3	5.21	5.46	5.33		
С	0.45	0.58	0.531		
D	6.00	6.20	6.10		
D1	5.21	-	-		
е	-	-	2.286		
Е	6.45	6.70	6.58		
E1	4.32	-	-		
Н	9.40	10.41	9.91		
٦	1.40	1.78	1.59		
L3	0.88	1.27	1.08		
L4	0.64	1.02	0.83		
а	0°	10°	-		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

TO252 (DPAK)



Dimensions	Value (in mm)			
С	4.572			
Х	1.060			
X1	5.632			
Y	2.600			
Y1	5.700			
Y2	10.700			



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